











CEF13N65S

650V Δ 270mΩ Δ 13.8ANote 4 Δ Si MOSFET

SILICON SI MOSFET ▲ THT type N-channel enhancement mode UL94V-0 rated flame retardant epoxy

TO220F-3L package ▲ Electrical insulated mounting tab Super high dense cell density for extremely low R_{DS(ON)} High power and current handling capability

MAXIMUM RATINGS

| Parameter (T _C = 25°C, unless otherwise noted) | | Characteristics |
|---|-----------------------------------|-----------------|
| Drain-Source Voltage | V _{DS} | 650V |
| Gate-Source Voltage | V _{GS} | ±30V |
| Continuous Drain Current at T _C = 25°C | I _D | 13.8A Note 4 |
| Continuous Drain Current at T _C = 100°C | I _D | 6.2A Note 4 |
| Pulsed Drain Current Note 1 | I _{DM} Note 5 | 55.2A Note 4 |
| Maximum Power Dissipation at T _C = 25°C | P _D | 60W |
| Power Dissipation Derating above 25°C | ΔP _D | 0.48W/°C |
| Single Pulsed Avalanche Energy Note 6 | E _{AS} | 306mJ |
| Single Pulsed Avalanche Current Note 6 | l _{AS} | 3.5A |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55°C to +150°C |

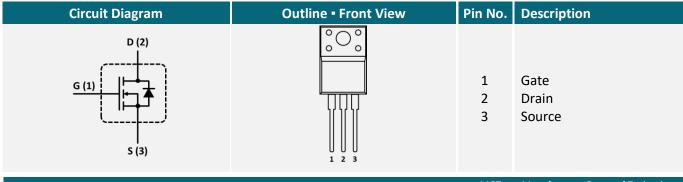
THERMAL CHARACTERISTICS

| Parameter | Symbol | Limit |
|---|--------------------|---------|
| Thermal Resistance, Junction-to-Case | R _{TH_JC} | 2.1°C/W |
| Thermal Resistance, Junction-to-Ambient | R _{TH JA} | 65°C/W |

APPLICATIONS

| EV Charging | Industrial Inverters | Motors & Drives | Power Factor Correction | Renewable Energy | SMPS | UPS |
|----------------|-------------------------|--------------------|----------------------------|---------------------|------|-----|
| ₹ | | | PFC | * | | |

PIN DESCRIPTION



MGT ▲ Manufacturer Group of Technology



ELECTRICAL CHARACTERISTICS ▲ T_C = 25°C, unless otherwise noted

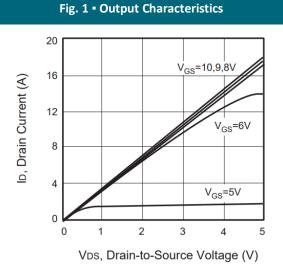
| Item | Condition | Symbol | Min. | Тур. | Max. | Unit |
|--|---|---------------------|------|------|------|------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | $V_{GS} = 0V, I_D = 250\mu A$ | BV_{DSS} | 650 | | | V |
| Zero Gate Voltage Drain Current | $V_{DS} = 650V, V_{GS} = 0V$ | I _{DSS} | | | 1 | μΑ |
| Gate Body Leakage Current, Forward | $V_{GS} = 30V$, $V_{DS} = 0V$ | I_{GSSF} | | | 100 | nA |
| Gate Body Leakage Current, Reverse | $V_{GS} = -30V$, $V_{DS} = 0V$ | I_{GSSR} | | | -100 | nA |
| On Characteristics Note 2 | | | | | | |
| Gate Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 250 \mu A$ | $V_{GS(th)}$ | 2.5 | | 4.5 | V |
| Static Drain-Source On-Resistance | $V_{GS} = 10V, I_D = 6A$ | R _{DS(ON)} | | 270 | 320 | mΩ |
| Dynamic Characteristics Note 3 | | | | | | |
| Input Capacitance | $V_{DS} = 150V$, $V_{GS} = 0V$, $f = 1MHz$ | C _{ISS} | | 910 | | pF |
| Output Capacitance | $V_{DS} = 150V$, $V_{GS} = 0V$, $f = 1MHz$ | Coss | | 60 | | pF |
| Reverse Transfer Capacitance | $V_{DS} = 150V$, $V_{GS} = 0V$, $f = 1MHz$ | C _{RSS} | | 15 | | pF |
| Switching Characteristics Note 3 | | | | | | |
| Turn-On Delay Time | V_{DD} = 400V, V_{GS} = 10V, I_{D} = 6A, $R_{G(ext)}$ = 10 Ω | t _{D(ON)} | | 30 | | ns |
| Turn-On Rise Time | V_{DD} = 400V, V_{GS} = 10V, I_D = 6A, $R_{G(ext)}$ = 10 Ω | t_R | | 13 | | ns |
| Turn-Off Delay Time | V_{DD} = 400V, V_{GS} = 10V, I_D = 6A, $R_{G(ext)}$ = 10 Ω | t _{D(OFF)} | | 65 | | ns |
| Turn-Off Fall Time | V_{DD} = 400V, V_{GS} = 10V, I_D = 6A, $R_{G(ext)}$ = 10 Ω | t _F | | 11 | | ns |
| Total Gate Charge | $V_{DS} = 400V$, $V_{GS} = 10V$, $I_D = 1A$ | Q_{G} | | 25 | | nC |
| Gate Source Charge | $V_{DS} = 400V$, $V_{GS} = 10V$, $I_D = 1A$ | Q_{GS} | | 4 | | nC |
| Gate Drain Charge | $V_{DS} = 400V$, $V_{GS} = 10V$, $I_D = 1A$ | Q_{GD} | | 10 | | nC |
| Drain-Source Diode Characteristics a | nd Maximum Ratings | | | | | |
| Drain-Source Diode Forward Current | | Is | | | 8.6 | Α |
| Drain-Source Diode Forward Voltage Note 2 | $V_{GS} = 0V$, $I_S = 8.6A$ | V_{SD} | | | 1.2 | V |
| Reverse Recovery Time | $I_D = 6A$, di/dt = 100A/ μ s | t _{RR} | | 240 | | ns |
| Reverse Recovery Charge | $I_D = 6A$, di/dt = 100A/ μ s | Q_{RR} | | 2.35 | | μC |
| Peak Reverse Recovery Current | $I_D = 6A$, di/dt = 100A/ μ s | I_{RR} | | 16.8 | | Α |

Notes

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature
- 2: Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 3: Guaranteed by design, not subject to production testing.
- 4: Limited only by maximum temperature allowed.
- 5: Pulse width limited by safe operating area.
- 6: L = 50mH, I_{AS} = 3.5A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C



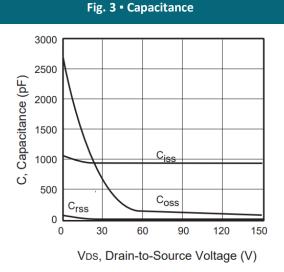
REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

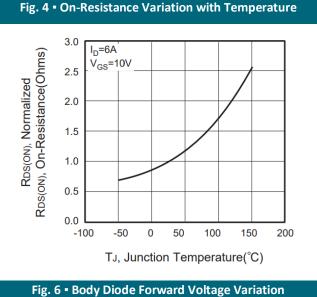


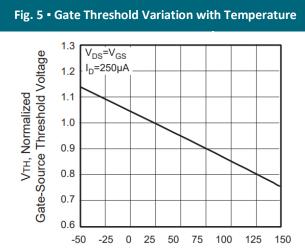
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Vgs, Gate-to-Source Voltage (V)

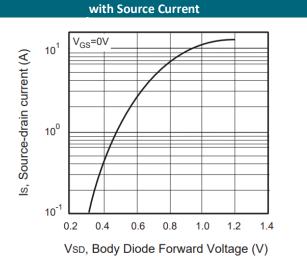
Fig. 2 • Transfer Characteristics







T_J, Junction Temperature(°C)



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REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

Fig. 7 • Gate Charge

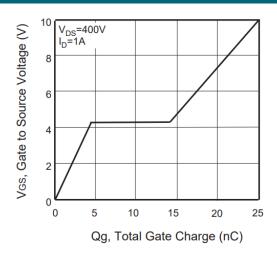


Fig. 8 • Maximum Safe Operating Area

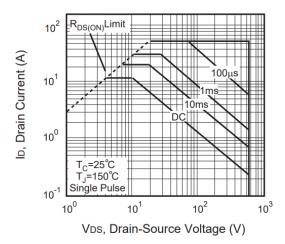
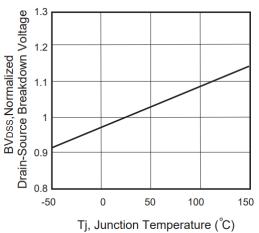


Fig. 9 • Breakdown Voltage Variation vs. Temperature





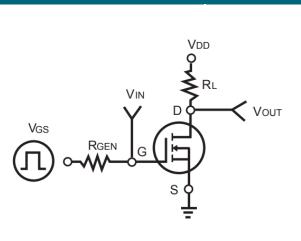
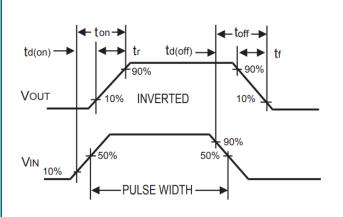


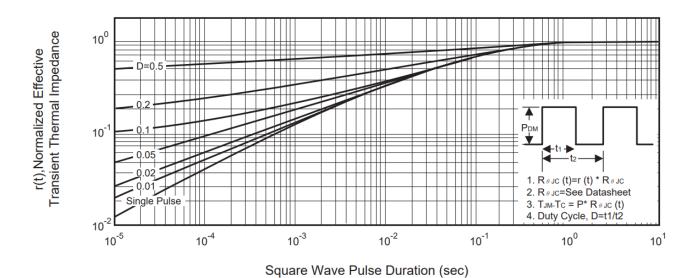
Fig. 11 • Switching Waveforms





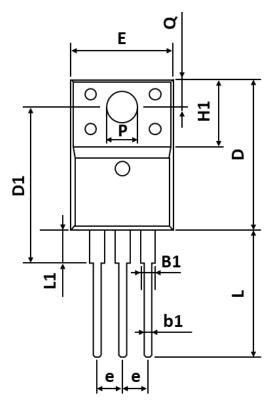
REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

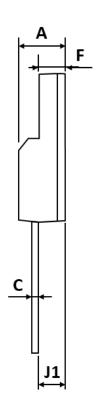
Fig. 12 • Normalized Thermal Transient Impedance Curve





PACKAGE OUTLINE





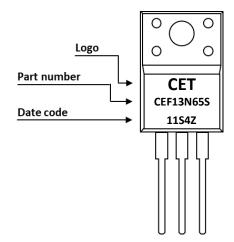
| Sym | Millimeters (Min.) | Millimeters (Typ.) | Millimeters (Max.) |
|-----|-----------------------|--------------------|-----------------------|
| Α | 4.500 | - | 5.000 |
| B1 | 1.000 | - | 1.500 |
| b1 | 0.700 | - | 0.950 |
| С | 0.420 | - | 0.700 |
| D | 15.670 | - | 16.070 |
| D1 | 14.800 | - | 16.000 |
| E | 9.960 | - | 10.360 |
| е | 2.340 | - | 2.740 |
| F | 2.340 | - | 2.740 |
| H1 | 6.480 | - | 6.900 |
| J1 | 2.550 | - | 2.950 |
| L | 12.080 | - | 13.480 |
| L1 | 2.230 | - | 3.650 |
| Q | 3.100 | - | 3.500 |
| Р | 2.980 | - | 3.380 |

ORDERING INFORMATION

| Part Number | Package | Packing | Tube Qty. | Inner Box Qty. | Outer Box Qty. |
|-------------|------------|---------|-----------|----------------|----------------|
| CEF13N65S | TO-220F-3L | Tube | 50pcs | 1,000pcs | 4,000pcs |

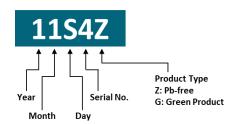


PART MARKING



DATE CODE

Example: 11S4Z



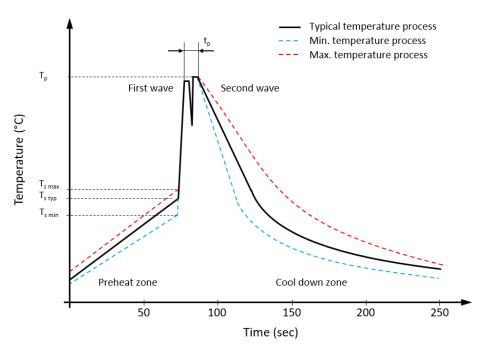


Coding list for "Day"





RECOMMENDED WAVE SOLDERING PROFILE A THT PACKAGE



Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

| Profile Features | | Value ▲ Sn-Pb Assembly | Value ▲ Pb-free Assembly |
|--|--------------------|--|--|
| Preheat temperature min. | T_{smin} | 100 °C | 100 °C |
| Preheat temperature typical | T _{s typ} | 120 °C | 120 °C |
| Preheat temperature max. | T_{smax} | 130 °C | 130 °C |
| Preheat time t_s from T_{smin} to T_{smax} | ts | 70 seconds | 70 seconds |
| Peak temperature | T_p | 235 °C to 260 °C | 245 °C to 260 °C |
| Time of actual peak temperature | t _p | Max. 10 seconds Max. 5 second each wave | Max. 10 seconds Max. 5 second each wave |
| Ramp-down date min. | | ~ 2 °C/second | ~ 2 °C/second |
| Ramp-down rate typical | | ~ 3.5 °C/second | ~ 3.5 °C/second |
| Ramp-down rate max. | | ~ 5 °C/second | ~ 5 °C/second |
| Time 25°C to 25°C | | 4 minutes | 4 minutes |



REVISION TABLE

| Revision | Date | Status | Notes |
|----------|------------|-----------------|---------------------|
| 001 | 30/09/2022 | Initial release | Initial publication |
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